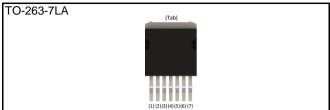
Datasheet



N-channel SiC power MOSFET

V _{DSS}	1200V
R _{DS(on)} (Typ.)	50mΩ
I _D *1	29A
P_{D}	115W

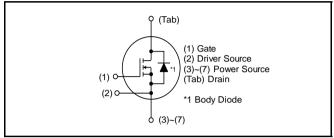
●Outline



Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant
- 7) Wide creepage distance = min.4.7 mm

•Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

Packaging specifications

Packing Reel size (mm)	Packing	Embossed tape
	Reel size (mm)	330
Typo	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT4050KWA

● **Absolute maximum ratings** (T_{vi} = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Drain - source voltage		V_{DSS}	1200	V	
Continuous drain	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I _D , I _S *1	29	А
and source current	VGS - VGS_on	$T_c = 100$ °C	ID, IS	21	А
Pulsed drain current	$V_{GS} = V_{GS_on}$	$T_c = 25^{\circ}C$	I _{D,pulse} *2	73	Α
Body diode pulsed forward current $T_c = 25$ °C		$T_c = 25^{\circ}C$	I _{S,pulse} *1,*3	29	Α
Body diode surge forward current		$V_{GS} = 0 V$	I _{S,pulse} *1,*4	73	Α
Gate - source voltage (DC)		V_{GSS_DC}	-4 to +21	V	
Gate - source surge voltage (t _{surge} < 300ns)		ns)	$V_{GSS_surge}^{*5}$	-4 to +23	V
Recommended turn-on gate - source drive voltage		ive voltage	${\sf V_{GS_on}}^{*6}$	+15 to +18	V
Recommended turn-off gate - source drive voltage		V_{GS_off}	0	V	
Virtual junction temperature		T_{vj}	175	°C	
Range of storage temperature			T_{stg}	-40 to +175	°C

ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Doromotor	Cymbol	Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	W	$V_{GS} = 0 \text{ V}, I_D = 7\text{mA}$				V
	V (BR)DSS	$T_{vj} = 25^{\circ}C$	1200	-	-	V
		$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{V}$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	80	μΑ
Diam current		T _{vj} = 150°C	-	10	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V , V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current		$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}^{*7}$	$V_{DS} = 10V, I_{D} = 8mA$	2.8	-	4.8	V
		$V_{GS} = 18V, I_{D} = 15A$				
Static Drain - Source on - state resistance	R _{DS(on)} *8	$T_{vj} = 25^{\circ}C$	-	50	65	mΩ
on state resistance		T _{vj} = 150°C	-	100	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	5	-	Ω

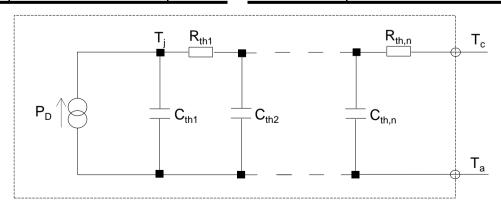
●Thermal resistance

Parameter	Symbol	Values			Unit
Falanielei		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	R _{thJC} *9	-	1.0	1.3	K/W

● Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	1.6 ×10 ⁻¹	
R _{th2}	4.5 ×10 ⁻¹	K/W
R _{th3}	3.9 ×10 ⁻¹	

Symbol	Value	Unit
C_{th1}	5.0 ×10 ⁻⁴	
C_{th2}	2.4 ×10 ⁻³	Ws/K
C _{th3}	1.3 ×10 ⁻²	



ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

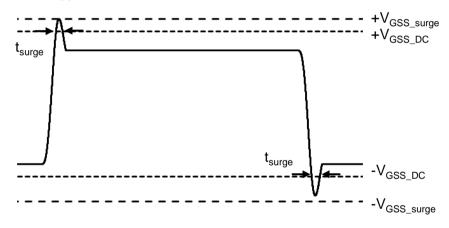
Davamatar	Cumple of	Canditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	g _{fs} *8	$V_{DS} = 10V, I_{D} = 15A$	-	7.4	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	1703	-	
Output capacitance	C _{oss}	V _{DS} = 800V	-	59	-	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	4	-	,
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 800V$	-	70	-	pF
Total Gate charge	Q _g *8	$V_{DS} = 800V$ $I_{D} = 15A$	-	71	-	
Gate - Source charge	Q _{gs} *8	$V_{GS} = 18V$	-	16	-	nC
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	-	23	-	
Turn - on delay time	t _{d(on)} *8	$V_{DS} = 800V$	-	5.2	•	
Rise time	t _r *8	$I_D = 15A$ $V_{GS} = +18V / 0V$	-	12	-	ns
Turn - off delay time	t _{d(off)} *8	$R_G = 1Ω$, L = 250μH E_{on} includes diode	-	34	-	113
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50 \text{nH}, C_{\sigma} = 10 \text{pF}$	-	14	-	
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	350	-	μJ
Turn - off switching loss	E _{off} *8		-	6	-	μυ
$V_{GS(on)} = +15V$ Short-circuit	- t _{sc} *10	$V_{DS} \le 800V$ $V_{DS,peak} \le 1200V$	-	4.5	-	μs
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_G = 2.2\Omega$	-	4.0	-	μs

●Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Parameter	Symbol	Symbol Conditions -		Values		
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V _{SD} *8	$V_{GS} = 0V, I_{S} = 15A$	ı	3.3	ı	V
Reverse recovery time	t _{rr} *8	$I_F = 15A$ $V_R = 800V$	ı	9	ı	ns
Reverse recovery charge	Q _{rr} *8	$di/dt = 3500A/\mu s$	-	110	-	nC
Peak reverse recovery current	I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	25	-	Α

^{*1} Limited by maximum T_{vj} and for Max. R_{thJC} .

*5 Example of acceptable V_{GS} waveform



- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying $V_{GS} = 21V$ for 100ms.
- *8 Pulsed
- *9 Measured conformable to JESD51-14.

See the application note "rthjc_measurement_and_usage_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc_measurement_and_usage_an-e.pdf

*10 The value is based on TO-247 package. Single Pulsed.

^{*2} Pulse width and duty cycle are limited by $T_{v_j,max}$.

^{*3} Only for body-diode, Repetitive pulse, PW ≤ 1.5µs, Duty cycle ≤ 5%

^{*4} When used as a protective function, PW \leq 10 μ s

Fig.1 Power Dissipation Derating Curve

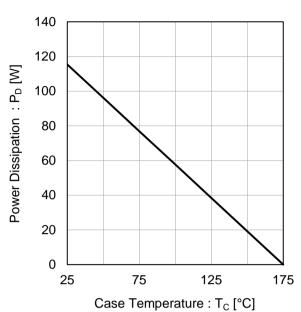


Fig.2 Maximum Safe Operating Area

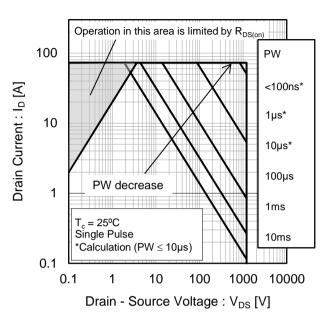
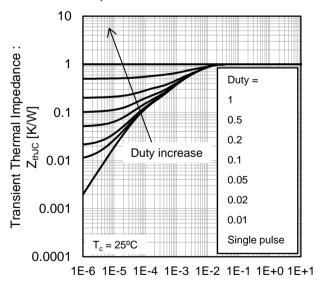


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width



Pulse Width: PW [s]

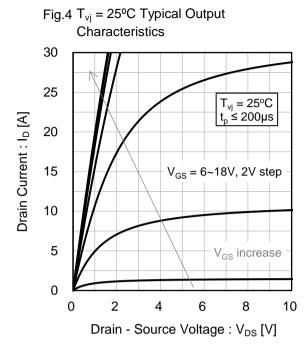


Fig.5 $T_{vj} = 25^{\circ}C$ 3rd Quadrant Characteristics $\begin{array}{c} 0 \\ T_{vj} = 25^{\circ}C \\ t_{p} \leq 200 \mu s \\ \end{array}$ -5 $\begin{array}{c} V_{GS} = -4V \\ V_{GS} = 0V \\ V_{GS} = 15V \\ V_{GS} = 18V \\ \end{array}$ -15 $\begin{array}{c} V_{GS} = 18V \\ \end{array}$ -20 $\begin{array}{c} V_{GS} = 18V \\ \end{array}$

-6

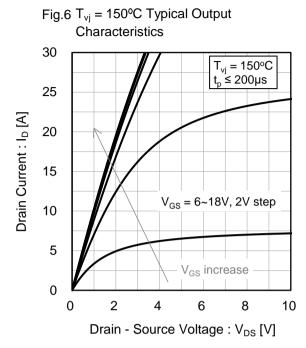
Drain - Source Voltage : V_{DS} [V]

-4

-30

-10

-8



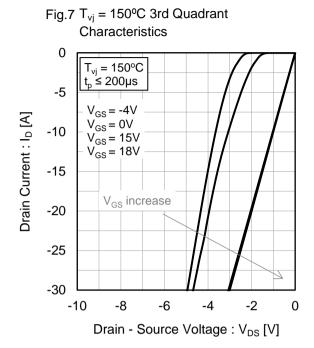


Fig.8 Body Diode Forward Voltage vs. Gate - Source Voltage

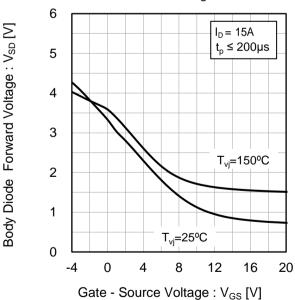


Fig.9 Typical Transfer Characteristics (I)

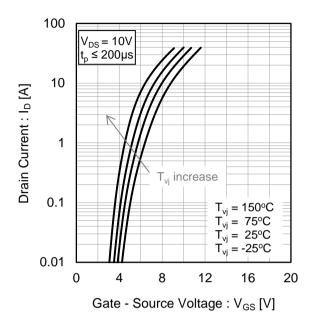


Fig.10 Typical Transfer Characteristics (II)

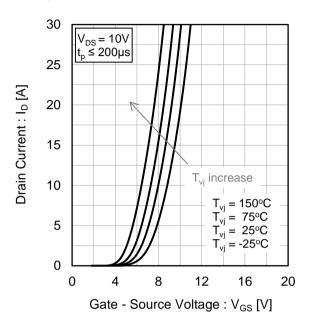


Fig.11 Gate Threshold Voltage vs. Virtual Junction Temperature

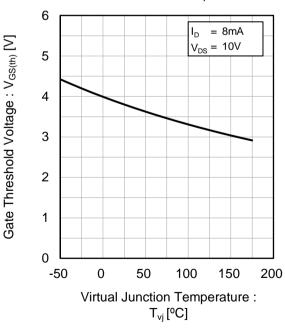
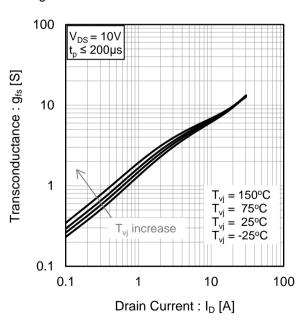
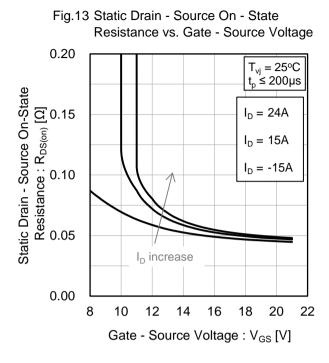


Fig.12 Transconductance vs. Drain Current





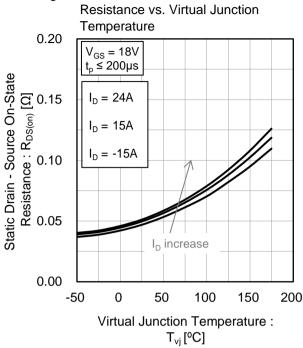
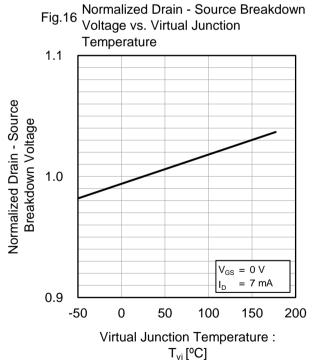
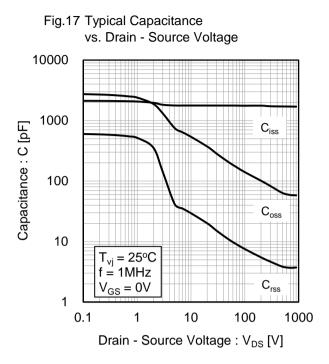


Fig.14 Static Drain - Source On - State

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current = 150°C = 125°C Static Drain - Source On-State = 75°C 25°C Resistance: R_{DS(on)} [Ω] -25°C 0.1 T_{vi} increase 0.01 $V_{GS} = 18V$ ≤ 200µs 0.001 10 100 Drain Current: I_D [A]



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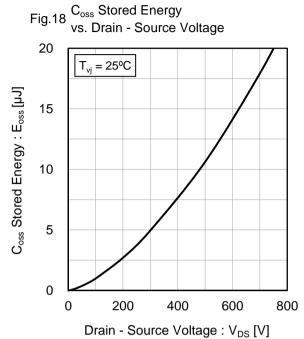


Fig.19 Dynamic Input Characteristics

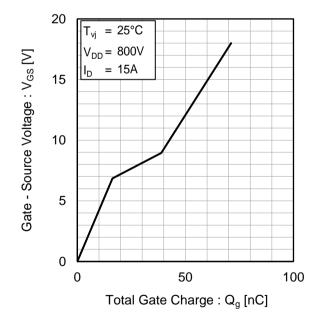
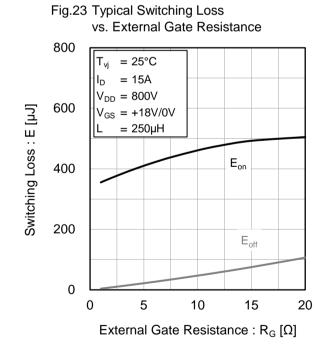


Fig.20 Typical Switching Time vs. External Gate Resistance 120 = 25°C = 15A $t_{d(off)}$ 100 $V_{DD} = 800V$ $V_{GS} = +18V/0V$ Switching Time: t [ns] $= 250 \mu H$ 80 60 $t_{d(o\underline{n})} \\$ 40 j t, i 20 ¦ t_f 0 5 10 15 20 External Gate Resistance : $R_G[\Omega]$

Fig.21 Typical Switching Loss vs. Drain - Source Voltage 800 = 25°C = 15A $V_{GS} = +18V/0V$ Switching Loss: E [µJ] 600 $R_G = 1\Omega$ $= 250 \mu H$ 400 E_{on} 200 E_{off} 0 400 600 200 800 Drain - Source Voltage: V_{DS} [V]

Fig.22 Typical Switching Loss vs. Drain Current 800 $T_{vj} = 25^{\circ}C$ $V_{DD} = 800V$ $V_{GS} = +18V/0V$ 600 Switching Loss : E [µJ] $R_G = 1\Omega$ $= 250 \mu H$ 400 E_{on} 200 0 0 5 10 15 25 20 30 Drain Current: ID [A]



ROHM

Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

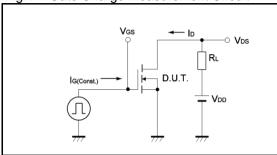


Fig.2-1 Switching Characteristics Measurement Circuit

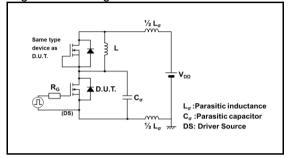


Fig.2-3 Waveforms for Switching Energy Loss

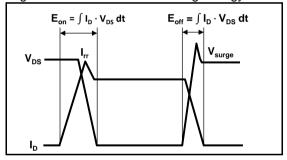


Fig.3-1 Reverse Recovery Time Measurement Circuit

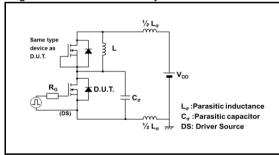


Fig.1-2 Gate Charge Waveform

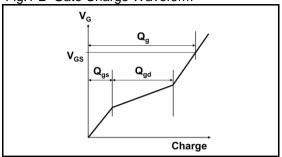


Fig.2-2 Waveforms for Switching Time

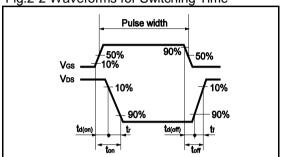
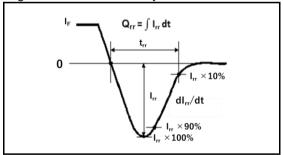
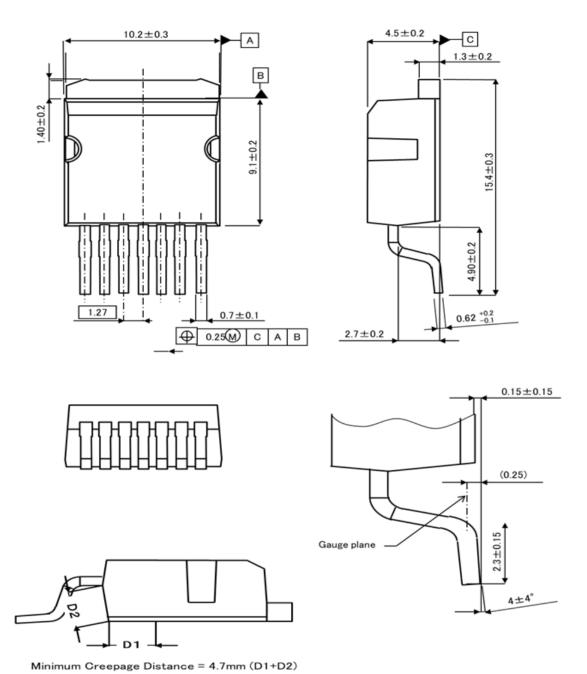


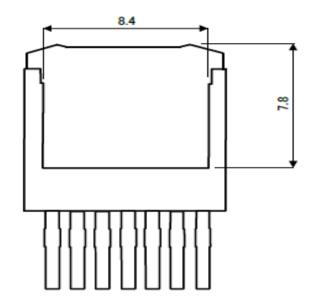
Fig.3-2 Reverse Recovery Waveform



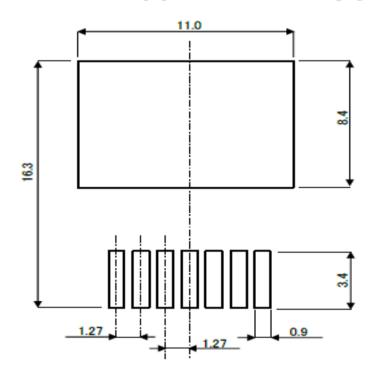
●Package Dimensions



Unit: mm



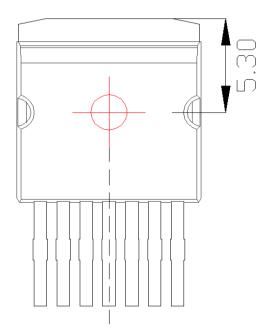
RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm

●Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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